

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application: : Group Art Unit: 1733
M. Gaynes et al : Examiner: J. Haran
Serial No.: 10/085,313 : IBM Corporation
Filed: 02/28/2002 : Intellectual Property Law
Title: METHOD FOR BONDING HEAT : Department IQ0A/040-3
SINKS TO OVERMOLD MATERIAL : 1701 North Street
: Endicott, NY 13760

Assistant Commissioner For Patents
Washington, DC 20231

#3/VAE

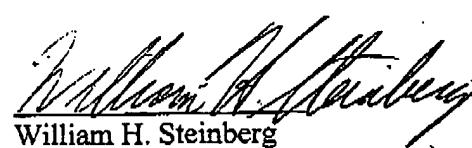
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**Change Of Attorney Or Agent's Address In Application
(37 CFR 1.8(a))**

Docket No.
END920010053US1

In Re Application Of: **M. Gaynes et al**

Serial No. 10/085,313	Filing Date 02/28/02	Examiner J. Haran	Group Art Unit 1733
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Invention: **METHOD FOR BONDING HEAT SINKS TO OVERMOLD MATERIAL**

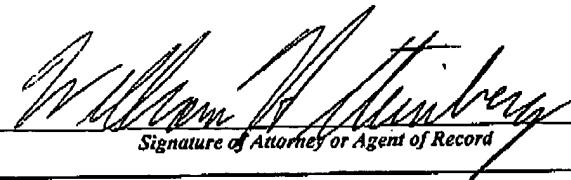
TO THE COMMISSIONER FOR PATENTS

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